



AZ23C5V6W, AZ23C6V8W, AZ23C10W, AZ23C18W

Moisture Sensitivity: Level 1 per J-STD-020D

Marking Information: See Table Below & Page 2

Terminal Connections: See Diagram

Ordering Information: See Page 2

Weight: 0.006 grams (approximate)

Terminals: Solderable per MIL-STD-202, Method 208

Lead Free Plating (Matte Tin Finish annealed over Alloy 42

Mechanical Data

Case: SOT-323

leadframe).

Device Schematic

200mW DUAL SURFACE MOUNT ZENER DIODE

Case Material: Molded Plastic, "Green" Molding Compound, Note 6. UL Flammability Classification Rating 94V-0

Features

- Nominal Zener Voltages: 5.6V, 6.8V, 10V, 18V
- Ultra-Small Surface Mount Package
- Ideal For Transient Suppression
- Lead Free/RoHS Compliant (Note 4)
- "Green" Device (Note 5 and 6)

ESD Sensitivity Rating

- AEC-Q101, HBM 8kV, MM 400V (AZ23C5V6W - AZ23C18W)
- IEC 61000-4-2, Air Exceeds 25kV, Contact 8kV (AZ23C5V6W, AZ23C6V8W)
- IEC 61000-4-2, Air Exceeds 15kV, Contact 8kV (AZ23C10W, AZ23C18W)



Top View

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.							
Characteristic	Symbol	Value	Unit				
Forward Voltage @ I _F = 10mA	V _F	0.9	V				

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	PD	200	mW
Thermal Resistance, Junction to Ambient Air (Note 1)	R _{0JA}	625	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-65 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Type Number	Marking Code	Zener Voltage Range (Note 2)			Maxi		er Imped te 3)	lance	Maximum Current		Tempe Coeffic Zener \ @ I _{ZT} :	ient of /oltage
		V _{Z@IZT}		V _{Z@IZT} Z _{ZT} @I _{ZT} Z _{ZI}		Z _{ZK} (@ I _{ZK}	I _R @	V _R	T _C (mV/°C)		
		Nom (V)	Min (V)	Max (V)	Ω	mA	Ω	mA	μA	V	Min	Max
AZ23C5V6W	KD9	5.6	5.32	5.88	40	5.0	400	1.0	1.0	2.0	-2.0	2.5
AZ23C6V8W	KDB	6.8	6.47	7.14	15	5.0	80	1.0	2.0	4.0	1.2	4.5
AZ23C10W	KDF	10	9.4	10.6	15	5.0	70	1.0	0.2	7.0	4.5	8.0
AZ23C18W	KDL	18	16.8	19.1	50	5.0	170	1.0	0.1	12.6	12.4	16.0

Notes:

Mounted on FR4 PC Board with recommended pad layout at http://www.diodes.com/datasheets/ap02001.pdf.
Short duration pulse test used to minimize self-heating.

3. f = 1KHz.

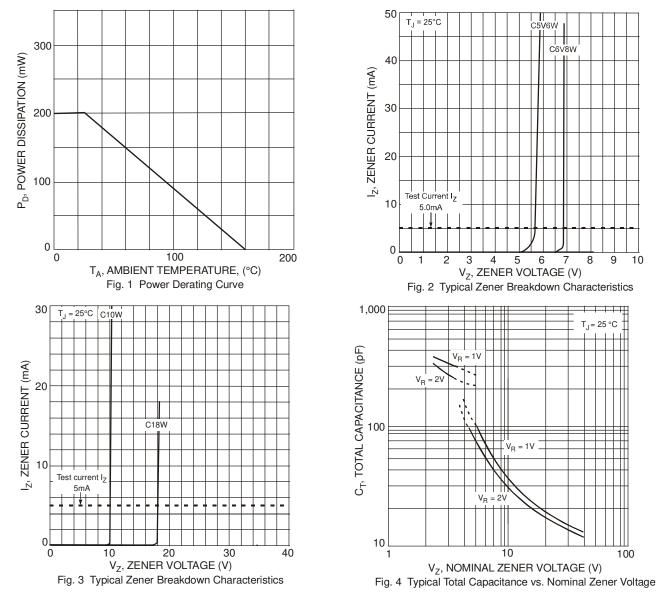
4. No purposefully added lead.

5. Diodes Inc.'s "Green" Policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

6. Product manufactured with date code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to date code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.



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Ordering Information (Notes 6 & 7)

Part Number	Case	Packaging
(Type Number)-7-F*	SOT-323	3000/Tape & Reel

* Add "-7-F" to the appropriate type number in Electrical Characteristics Table from Page 1 example: 6.8V Zener = AZ23C6V8W-7-F.

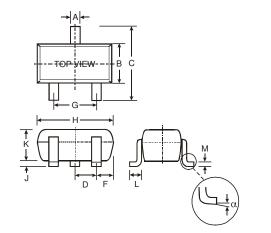
Notes: 7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information

Date Code Key				Ĺ	xxx	MY	See E YM = Y = Y	Electrica Date C ear (ex:	l Charac ode Marl N = 200	0	able				
Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2111	2012
Code	J	K	L	М	Ν	Р	R	S	Т	U	V	W	Х	Y	Z
Month	Jan	Feb		Mar	Apr	May	Ju	n	Jul	Aug	Sep	Oc	t	Nov	Dec
Code	1	2		3	4	5	6		7	8	9	0		N	D
AZ23C5V6W, AZ23C10W, A Document number:	Z23C1	8W				www	2 of 3 .diodes.	com							May 2008 Incorporated

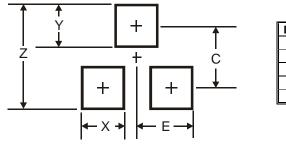


Package Outline Dimensions



	SOT-323						
Dim	Min	Max					
Α	0.25	0.40					
В	1.15	1.35					
С	2.00	2.20					
D	0.65 N	ominal					
F	0.30	0.40					
G	1.20	1.40					
н	1.80	2.20					
J	0.0	0.10					
K	0.90	1.00					
L	0.25	0.40					
М	0.10	0.18					
α	0°	8°					
All Di	All Dimensions in mm						

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Y	0.9
С	1.9
E	1.0

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